

# **AOZ1361DI** 28V/2A Programmable Current-Limited Load Switch

# **General Description**

The AOZ1361DI is a high-side load switch intended for applications that require circuit protection. The device operates from voltages between 4.5V and 28V, and can handle a continuous current up to 3A. The internal current limiting circuit protects the input supply voltage from large load current. The current limit can be set with an external resistor. The AOZ1361DI provides thermal protection function that limits excessive power dissipation. An open-drain fault indicator pulls low when an over-current or thermal shutdown event occurs. The device employs internal soft-start circuitry to control inrush current due to highly capacitive loads associated with hot-plug events. It features low quiescent current of 220µA and the supply current reduces to less than 1µA in shutdown.

The AOZ1361DI is available in a 10-pin 4x4 DFN package and can operate over -40°C to +85°C temperature range.

## Features

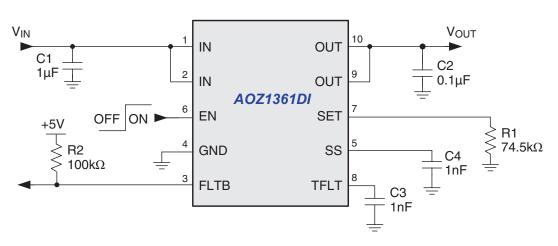
- 35mΩ maximum on resistance
- 2A minimum continuous current
- Programmable current limit
- 4.5V to 28V operating input voltage
- Low quiescent current
- Under-voltage lockout
- Thermal shutdown protection
- Open-drain fault indicator with delay
- Small 4x4 DFN package
- 2.5kV ESD rating

## Applications

- Notebook PCs
- Hot swap supplies



# **Typical Application**





## **Ordering Information**

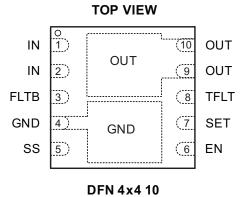
Part Number	Feature	Package	Temperature Range	Environmental
AOZ1361DI-01	Auto-restart	DFN 4x4 10	-40°C to +85°C	RoHS Compliant
AOZ1361DI-02	Latch-off			Green Product



AOS Green Products use reduced levels of Halogens, and are also RoHS compliant.

Please visit www.aosmd.com/web/quality/rohs\_compliant.jsp for additional information.

# **Pin Configuration**



# **Pin Description**

Pin Number	Pin Name	Pin Function
1, 2	IN	P-channel MOSFET source. Connect a 1µF capacitor from IN to GND.
3	FLTB	Fault output pin. This is an open drain output that is internally pulled low to indicate a fault condition. Connect to 5V thru a pull up resistor.
4	GND	Ground.
5	SS	Soft-Start Pin. Connect a capacitor from SS to GND to set the soft-start time.
6	EN	Enable Input.
7	SET	Current Limit Set Pin. Connect a resistor from SET to GND to set the switch current limit.
8	TFLT	Fault Delay pin. Connect a capacitor from TFLT to GND to set the Fault delay time.
9, 10	OUT	P-channel MOSFET Drain. Connect a 0.1µF capacitor from OUT to GND.



## Absolute Maximum Ratings

Exceeding the Absolute Maximum ratings may damage the device.

Parameter	Rating
IN to GND	-0.3V to +30V
EN, OUT to GND	-0.3V to V <sub>IN</sub> +0.3V
FLTB, TFLT, SS, SET	-0.3V to +6V
Maximum Continuous Current	3A
Maximum Junction Temperature (T <sub>J</sub> )	+150°C
ESD Rating (HBM)	2.5kV

## **Recommend Operating Ratings**

The device is not guaranteed to operate beyond the Maximum Operating Ratings.

Parameter	Rating
Thermal Resistance (DFN 4x4)	63°C/W

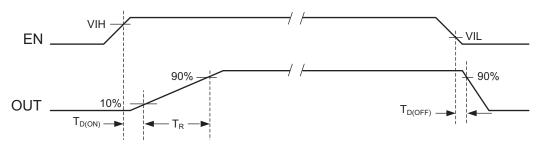
## **Electrical Characteristics**

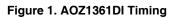
 $V_{IN} = 12V$ ,  $T_A = 25^{\circ}C$  unless otherwise stated.

Symbol	Parameter	Conditions	Min.	Тур.	Max	Units
V <sub>IN</sub>	Input Supply Voltage		4.5		28	V
V <sub>UVLO</sub>	Undervoltage Lockout Threshold	IN rising		3.9	4.4	V
V <sub>UVHYS</sub>	Undervoltage Lockout Hysteresis			200		mV
I <sub>IN_ON</sub>	Input Quiescent Current	EN = IN, no load		300	500	μA
I <sub>IN_OFF</sub>	Input Shutdown Current	EN = GND, no load			1	μA
I <sub>LEAK</sub>	Output Leakage Current	EN = GND, no load			1	μA
R <sub>DS(ON)</sub>	Switch On Resistance	V <sub>IN</sub> = 12V		22	35	mΩ
		V <sub>IN</sub> = 4.5V		33	43	11122
I <sub>LIM</sub>	Current Limit	$R_{SET} = 74.5 k\Omega$	2	2.7	3.4	А
V <sub>EN_H</sub>	Enable Input Low Voltage				0.8	V
$V_{EN_L}$	Enable Input High Voltage		2.0			V
V <sub>EN_HYS</sub>	Enable Input Hysteresis			100		mV
I <sub>EN_BIAS</sub>	Enable Input Bias Current				1	μA
Td_on	Turn-On Delay Time EN_50% to OUT_10%	$R_L$ =120 $\Omega$ , $C_L$ = 1 $\mu$ F, SS = Floated. Measure from 50% of EN voltage to 10% of OUT voltage		280		μs
t <sub>ON</sub>	Turn-On Rise Time OUT_10% to 90%	$R_L$ =120 $\Omega$ , $C_L$ = 1 $\mu$ F, SS = Floated. Measure from 10% of OUT voltage to 90% of OUT voltage		220		μs
		$R_L=120\Omega, C_L=1\mu F, C_{SS}=1nF$		360		μs
t <sub>OFF</sub>	Turn-Off Fall Time	$R_L$ =120 $\Omega$ , $C_L$ = 1 $\mu$ F, SS = Floated		280		μs
R <sub>DS(FLTB)</sub>	On-Resistance at FLTB	Sink current = 4mA			100	Ω
I <sub>LEAK_FLT</sub>	FLT Output Leakage				1	μA
TFLT	FLT Delay Period	C <sub>TLT</sub> = 1nF		600		μs
T <sub>SD</sub>	Thermal Shutdown Threshold			130		°C
T <sub>SD_HYS</sub>	Thermal Shutdown Hysteresis			30		°C



# **Timing Diagram**





## **Functional Block Diagram**

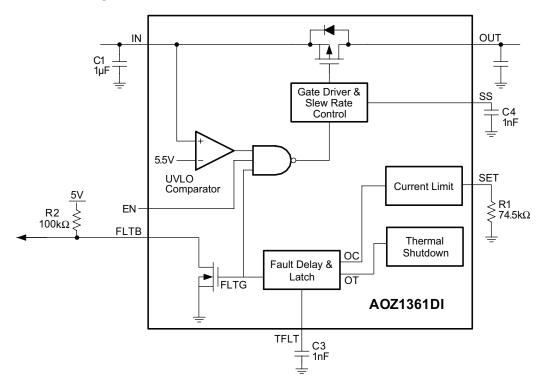
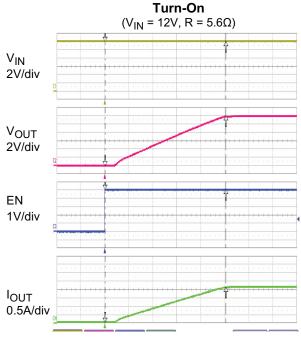


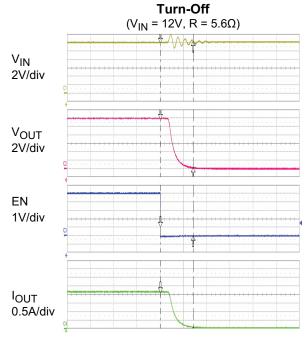
Figure 2. AOZ1361DI Functional Block Diagram



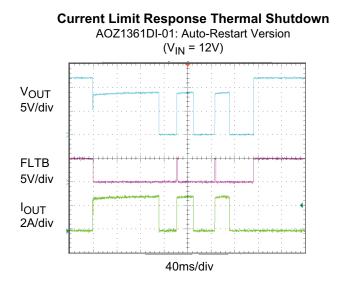
## **Functional Characteristics**



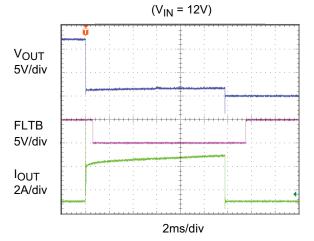
1ms/div



20µs/div

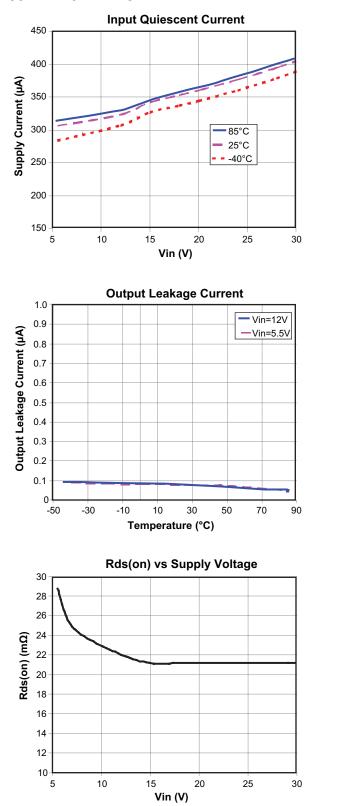


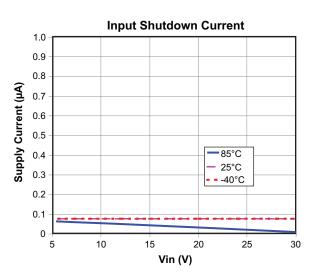
Current Limit Response Thermal Shutdown AOZ1361DI-02: Latch-off Version

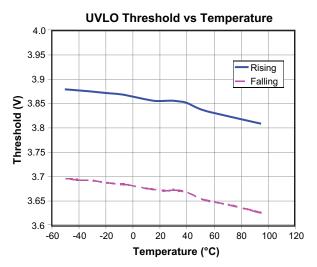


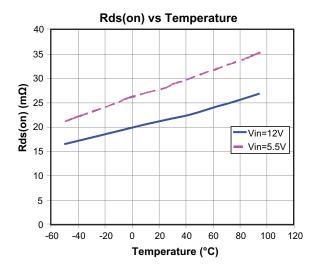


# **Typical Operating Characteristics**



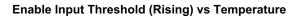


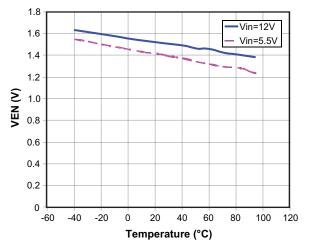




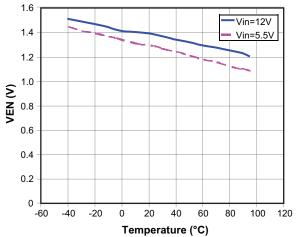


# Typical Operating Characteristics (Continued)





Enable Input Threshold (Falling) vs. Temperature





## **Detailed Description**

## Introduction

The AOZ1361DI is a  $35m\Omega$  P-channel high-side load switch with adjustable soft-start slew-rate control, programmable current limit and thermal shutdown. It operates with an input voltage range from 4.5V to 28V and can handle a continuous current of 2.7A.

#### Enable

The EN pin is the ON/OFF control for the output switch. It is an active-high input. The EN pin is active after VIN is above the UVLO threshold of 4V. Conversely, the Enable will be de-activated if the VIN falls below the UVLO of 4V. The EN pin must be driven to a logic high or logic low state to guarantee operation. While disabled, the AOZ1361DI only draws about 1 $\mu$ A supply current. The EN is a high impedance input with an ESD protection diode to ground and should not be forced below ground. This input level is compatible with most microcontroller outputs and other logic families.

## Under-Voltage Lockout (UVLO)

The under-voltage lockout (UVLO) circuit of AOZ1361DI monitors the input voltage and prevents the output MOSFET from turning on until VIN exceeds 4V.

#### Adjustable Soft-Start Slew-Rate Control

When the EN pin is asserted high, the slew rate control circuitry applies voltage on the gate of the PMOS switch in a manner such that the output voltage and current is ramped up linearly until it reaches the steady-state load current level. The slew rate can be adjusted by an external capacitor connected to the SS pin to ground. The slew rate rise time, Ton, can be set using the following equation:

$$Ton = \frac{Css \times V_{IN}}{30 \mu A}$$

## **Programmable Current Limit**

The current limit is programmed by an external resistor connected to the SET pin to ground. This sets a reference voltage to the current limit error amplifier that compares it to a sensed voltage that is generated by passing a small portion of the load current through an internal amplifier. When the sensed load current exceeds the set current limit, the load current is then clamped at the set limit and the Vout drops to whatever voltage necessary to clamp the load current. The AOZ1361DI will stay in this condition until the load current no longer exceeds the current limit or if the thermal shutdown protection is engaged. To set the current limit use Figure 3 on the following page.

## **Thermal Shut-down Protection**

The thermal overload protection of AOZ1361DI is engaged to protect the device from damage should the die temperature exceeds safe margins due to a short circuit, extreme loading or heating from external sources.

- AOZ1361DI-01 (Auto-restart version): During current limit or short circuit conditions, the PMOS resistance is increased to clamp the load current. This increases the power dissipation in the chip causing the die temperature to rise. When the die temperature reaches 130°C the thermal shutdown circuitry will shutdown the device. There is a 30°C hysterisis after which the device will turn back on and go thru soft start. The thermal shutdown will cycle repeatedly until the short circuit condition disappears or the enable pin is pulled LOW by an external monitor.
- AOZ1361DI-02 (Latch-off version): Thermal shut-down protection sets a fault latch and shuts off the internal MOSFET and asserts the FLT output if the junction temperature exceeds +130°C. The AOZ1361DI can be re-enabled by toggling EN pin or cycling the input supply after the die temperature drops below +100°C.

## FLTB

The FLTB pin is an open drain output that is asserted low when either an over-current, short-circuit or thermal overload condition occurs. To prevent false alarm, the AOZ1361DI implements a 600 $\mu$ s fault delay time for OT, over-current and short-circuit fault conditions. The FLTB pin becomes high impedance when the fault conditions are removed. A 100k $\Omega$  pull-up resistor must be connected between FLTB to 5V to provide a logic signal.

#### TFLT

TFLT is a fault delay pin, and its delay time is adjustable by a capacitor connected from TFLT to GND.



## **Applications Information**

#### **Input Capacitor Selection**

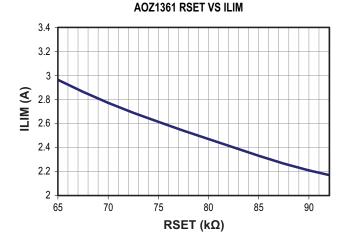
The input capacitor prevents large voltage transients from appearing at the input, and provides the instantaneous current needed each time the switch turns on and to limit input voltage drop. Also it is to prevent high-frequency noise on the power line from passing through the output of the power side. The choice of the input capacitor is based on its ripple current and voltage ratings rather than its capacitor value. The input capacitor should be located as close to the VIN pin as possible. A 1 $\mu$ F ceramic cap is recommended. However, higher capacitor values further reduce the voltage drop at the input.

#### **Output Capacitor Selection**

The output capacitor acts in a similar way. A small  $0.1\mu$ F capacitor prevents high-frequency noise from going into the system. Also, the output capacitor has to supply enough current for a large load that it may encounter during system transients. This bulk capacitor must be large enough to supply fast transient load in order to prevent the output from dropping.

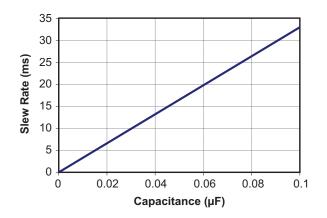
## **Current Limit Setting**

The current limit is program by using external resistor connected to the SET pin. To set the current limit, use the Figure 3 below.



#### Slew Rate Setting

Slew rate is set by changing the capacitor value on the Slew pin of the device. A capacitor connected between this SS pin and ground will reduce the output slew-rate. The capacitive range is  $0.001\mu$ F to  $0.1\mu$ F. See Figure 4 for Output Slew Rate Adjustment vs. Capacitance.



#### Figure 4. Output Slew Rate Adjustment vs. Capacitance

#### **Power Dissipation Calculation**

Calculate the power dissipation for normal load condition using the following equation:

$$P_{\rm D} = R_{\rm ON} \times (I_{\rm OUT})^2$$

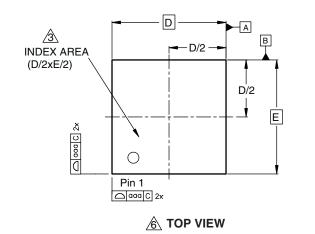
The worst case power dissipation occurs when the load current hits the current limit due to over-current or short circuit faults. The power dissipation under these conditions can be calculated using the following equation:

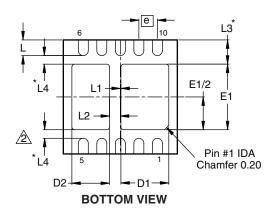
 $P_D = (V_{IN} - V_{OUT}) \times I_{LIMIT}$ 

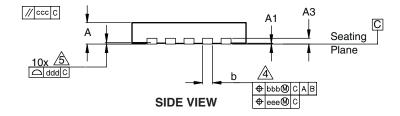
#### **Layout Guidelines**

Good PCB layout is important for improving the thermal and overall performance of AOZ1361. To optimize the switch response time to output short-circuit conditions keep all traces as short as possible to reduce the effect of unwanted parasitic inductance. Place the input and output bypass capacitors as close as possible to the IN and OUT pins. The input and output PCB traces should be as wide as possible for the given PCB space. Use a ground plane to enhance the power dissipation capability of the device.

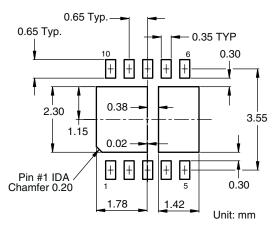
# Package Dimensions, DFN 4x4







#### **RECOMMENDED LAND PATTERN**



ons in	millim	eters
Min.	Nom.	Max.
0.70	0.75	0.80
0.00	0.02	0.05
0	.203 RE	F
0.30	0.35	0.40
3.95	4.00	4.05
1.58	1.68	1.78
1.22	1.32	1.42
3.95	4.00	4.05
2.20	2.30	2.40
(	).65 BSC	)
0.50	0.55	0.60
—	0.02	0.12
0.28	0.38	0.48
(	).85 REF	-
(	).30 REF	-
	0.15	
	0.10	
	0.10	
	0.08	
	0.05	
	Min. 0.70 0.00 0.30 3.95 1.58 1.22 3.95 2.20 ( 0.50  0.28 (	0.70 0.75 0.00 0.02 0.203 RE 0.30 0.35 3.95 4.00 1.58 1.68 1.22 1.32 3.95 4.00 2.20 2.30 0.65 BSC 0.50 0.55 — 0.02 0.28 0.38 0.85 REF 0.30 REF 0.15 0.10 0.10 0.08

#### Dimensions in inches

5	Dimer	isions	in inci	nes
	Symbols	Min.	Nom.	Max.
1	A	0.028	0.030	0.031
	A1	0.000	0.001	0.002
	A3	0	.008 RE	F
	b	0.012	0.014	0.016
	D	0.156	0.157	0.159
	D1	0.062	0.066	0.070
	D2	0.048	0.052	0.056
	E	0.156	0.157	0.159
	E1	0.087	0.091	0.094
	е	0	.026 BS	С
	L	0.020	0.022	0.024
	L1	—	0.001	0.005
	L2	0.011	0.015	0.019
	L3	0	.033 REI	F.
	L4	0	.012 RE	F
	aaa		0.006	
	bbb		0.004	
	CCC		0.004	
	ddd		0.003	
	eee		0.002	

#### Notes:

1. All dimensions are in millimeters.

2 The dimensions with \* are just for reference.

3. The location of the terminal #1 identifier and terminal numbering convention conforms to JEDEC publication 95 SPP-002.

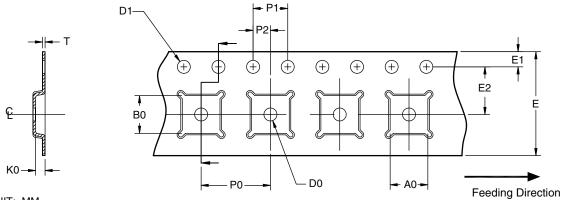
A. Dimension b applies to metallized terminal and is measured between 0.15mm and 0.30mm from the terminal tip. If the terminal has the optional radius on the other end of the terminal, then dimension b should not be measured in that radius area.

5 Coplanarity applies to the terminals and all other bottom surface metallization.

6. Drawings shown are for illustration only.

## Tape and Reel Dimensions, DFN 4x4

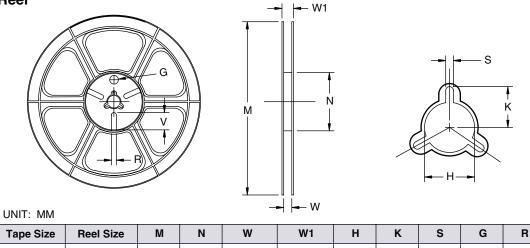
# **Carrier Tape**



UNIT: MM

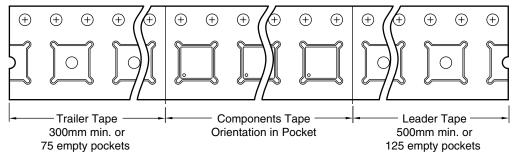
Package	A0	B0	К0	D0	D1	Е	E1	E2	P0	P1	P2	т
DFN 4x4	4.35	4.35	1.10	1.50	1.50	12.0	1.75	5.50	8.00	4.00	2.00	0.30
(12mm)	0.10	0.10	0.10	Min.	+0.1/-0.0	0.3	0.10	0.05	0.10	0.10	0.05	0.05

Reel



12 mm Ø330 Ø30.0 Ø79.0 12.4 17.0 Ø13.0 10.5 2.0 — —
---

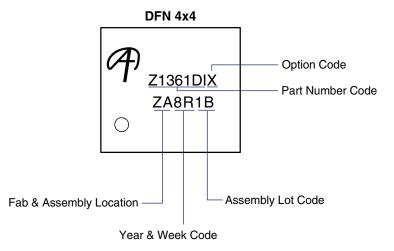
## Leader/Trailer and Orientation



v



## Package Marking



#### LEGAL DISCLAIMER

Applications or uses as critical components in life support devices or systems are not authorized. AOS does not assume any liability arising out of such applications or uses of its products. AOS reserves the right to make changes to product specifications without notice. It is the responsibility of the customer to evaluate suitability of the product for their intended application. Customer shall comply with applicable legal requirements, including all applicable export control rules, regulations and limitations.

AOS' products are provided subject to AOS' terms and conditions of sale which are set forth at: <u>http://www.aosmd.com/terms\_and\_conditions\_of\_sale</u>

#### LIFE SUPPORT POLICY

ALPHA & OMEGA SEMICONDUCTOR PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user. 2. A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.